

Description: BGA Emulator Foot (solder base).

100 position terminal pins (UGA, Ultra Minigrid Array) to SM balls. Surface mounts to target BGA land pattern.

SF-BGA100B-B-11 Drawing	Status: Released	Scale	-	Rev: B	Tolerances: diameters ±0.03mm [±0.001"], PCB perimeters ±0.13mm [±0.005"],	
© 2000 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com	Drawing: K Gilbertson		Date: 05/25/00		PCB thicknesses ±0.18mm [±0.007"], pitches (from true position) ±0.08mm [±0.003"], all other tolerances ±0.13mm [±0.005"]	
	File: SF-BGA100B-B-11 Dwg.mc	d	Modified: 1/	10/03	unless stated otherwise. Materials and specifications are subject to change without notice	